



(A)

500.39241X00

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): TENMEI et al.

Serial No.: 09/698,168

Filed: October 30, 2000

For: SEMICONDUCTOR DEVICE

Group: 2814

Examiner: D. Nguyen

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TECHNOLOGY CENTER 2800
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AMENDMENT

Assistant Commissioner
for Patents
Washington, D.C. 20231

November 4, 2002

9/11/02
Action &
Amend
11/13/02
D. Nguyen

11/15/2002 DBROWN 00000003 012135 09698168

01 FC:1201

84.00 CH

In response to the Office Action dated October 2, 2002, please amend the
above-identified application as follows:

In the Claims:

Please add new claims 23-34 as follows:

-- 23. A semiconductor apparatus comprising:

a semiconductor device;

an electrically insulating layer formed on said semiconductor device;

an external connection terminal formed on said electrically insulating layer;

and

a wiring formed on said electrically insulating layer and provided to electrically

connect a circuit electrode of said semiconductor device and said external

11/15/2002 CCBAU1 00000075 09698168

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